

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT4039712

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
LEFENG LIU	08/31/2016
YUMIAO WU	08/31/2016
DINGKAI XING	08/31/2016
XIONGYUAN FANG	08/31/2016
XINPU CHEN	08/31/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	UBTECH ROBOTICS CORP.
<b>Street Address:</b>	22ND FLOOR, BLOCK C1, NANSHAN I PARK
<b>Internal Address:</b>	NO. 1001 XUEYUAN ROAD, NANSHAN DISTRICT
<b>City:</b>	SHENZHEN
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29576601
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	chewpatentsgroup@gmail.com, 54968925@qq.com
<b>Correspondent Name:</b>	CHEW PATENTS GROUP
<b>Address Line 1:</b>	28039 SCOTT RD
<b>Address Line 2:</b>	SUITE D-180
<b>Address Line 4:</b>	MURRIETA, CALIFORNIA 92563
<b>ATTORNEY DOCKET NUMBER:</b>	2016A2US015
<b>NAME OF SUBMITTER:</b>	RAYMOND J. CHEW
<b>SIGNATURE:</b>	/RAYMOND J. CHEW/
<b>DATE SIGNED:</b>	09/06/2016
<b>Total Attachments: 2</b>	
source=2016A2US015_ASM#page1.tif	



## ASSIGNMENT

WHEREAS Lefeng Liu; Yumiao Wu; Dingkai Xing; Xiongyuan Fang; Ximpu Chen, the assignors, whose mailing address is/are 22nd Floor, Block C1, Nanshan I Park, No. 1001 Xueyuan Road, Nanshan District, Shenzhen, Guangdong, China,

have invented certain new and useful improvements in an invention relating to and entitled CONSTRUCTION SET BLOCK, the invention, as fully set forth and described in an application for Letters Patent to be filed at the United States Patent and Trademark Office and naming the assignors as inventors and applicants;

AND WHEREAS UBTECH Robotics Corp. of China, the assignee, whose mailing address is 22nd Floor, Block C1, Nanshan I Park, No. 1001 Xueyuan Road, Nanshan District, Shenzhen, Guangdong, China,

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to Any Letters Patent that may be obtained therefor;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, receipt of which is hereby acknowledged, the assignors, do hereby confirm that they have sold, assigned and transferred, and do hereby sell, assign and transfer to the assignee the full and exclusive right to the said invention in the United States and their entire right, title and interest for the United States in and to the invention, together with their entire right, title and interest in and to said application, any and all divisional applications thereof, and any and all Letters Patent of the United States which may issue or be reissued for the invention;

AND the assignors hereby authorize and request the Director of the United States Patent and Trademark Office to issue to said assignee of any and all said Letters Patent not already issued as the assignee of their entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by the assignors had this assignment and sale not been made.

AND the assignors, on behalf of themselves and their executors and administrators, hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent of the United States for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

*page 1 of 2*

Cont: Assignment

CONSTRUCTION SET BLOCK

Lefeng Liu [Signature of Inventor], SIGNED on this [31th] day of [August], 2016  
Lefeng Liu

Yumiao Wu [Signature of Inventor], SIGNED on this [31th] day of [August], 2016  
Yumiao Wu

Dingkai Xing [Signature of Inventor], SIGNED on this [31th] day of [August], 2016  
Dingkai Xing

Xiongyun Fang [Signature of Inventor], SIGNED on this [31th] day of [August], 2016  
Xiongyun Fang

Xinpu Chen [Signature of Inventor], SIGNED on this [31th] day of [August], 2016  
Xinpu Chen